



**ALPHA & OMEGA**  
SEMICONDUCTOR

**AO4414**

**N-Channel Enhancement Mode Field Effect Transistor**

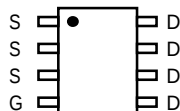


### General Description

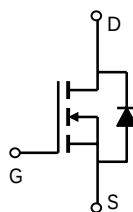
The AO4414 uses advanced trench technology to provide excellent  $R_{DS(ON)}$  and low gate charge. This device is suitable for use as a load switch or in PWM applications. The source leads are separated to allow a Kelvin connection to the source, which may be used to bypass the source inductance. *Standard Product AO4414 is Pb-free (meets ROHS & Sony 259 specifications). AO4414L is a Green Product ordering option. AO4414 and AO4414L are electrically identical.*

### Features

$V_{DS}$  (V) = 30V  
 $I_D$  = 8.5A ( $V_{GS}$  = 10V)  
 $R_{DS(ON)} < 26m\Omega$  ( $V_{GS}$  = 10V)  
 $R_{DS(ON)} < 40m\Omega$  ( $V_{GS}$  = 4.5V)



**SOIC-8**



### Absolute Maximum Ratings $T_A=25^\circ\text{C}$ unless otherwise noted

| Parameter                              | Symbol         | Maximum    | Units            |
|----------------------------------------|----------------|------------|------------------|
| Drain-Source Voltage                   | $V_{DS}$       | 30         | V                |
| Gate-Source Voltage                    | $V_{GS}$       | $\pm 20$   | V                |
| Continuous Drain Current <sup>A</sup>  | $I_D$          | 8.5        | A                |
| $T_A=25^\circ\text{C}$                 |                |            |                  |
| $T_A=70^\circ\text{C}$                 |                | 7.1        |                  |
| Pulsed Drain Current <sup>B</sup>      | $I_{DM}$       | 50         |                  |
| Power Dissipation                      | $P_D$          | 3          | W                |
| $T_A=25^\circ\text{C}$                 |                |            |                  |
| $T_A=70^\circ\text{C}$                 |                | 2.1        |                  |
| Junction and Storage Temperature Range | $T_J, T_{STG}$ | -55 to 150 | $^\circ\text{C}$ |

### Thermal Characteristics

| Parameter                                |              | Symbol          | Typ | Max | Units              |
|------------------------------------------|--------------|-----------------|-----|-----|--------------------|
| Maximum Junction-to-Ambient <sup>A</sup> | $t \leq 10s$ | $R_{\theta JA}$ | 31  | 40  | $^\circ\text{C/W}$ |
| Maximum Junction-to-Ambient <sup>A</sup> | Steady-State |                 | 59  | 75  | $^\circ\text{C/W}$ |
| Maximum Junction-to-Lead <sup>C</sup>    | Steady-State | $R_{\theta JL}$ | 16  | 24  | $^\circ\text{C/W}$ |

Electrical Characteristics ( $T_J=25^\circ\text{C}$  unless otherwise noted)

| Symbol                      | Parameter                             | Conditions                                                                         | Min | Typ        | Max      | Units            |
|-----------------------------|---------------------------------------|------------------------------------------------------------------------------------|-----|------------|----------|------------------|
| <b>STATIC PARAMETERS</b>    |                                       |                                                                                    |     |            |          |                  |
| $BV_{DSS}$                  | Drain-Source Breakdown Voltage        | $I_D=250\mu\text{A}$ , $V_{GS}=0\text{V}$                                          | 30  |            |          | V                |
| $I_{DSS}$                   | Zero Gate Voltage Drain Current       | $V_{DS}=24\text{V}$ , $V_{GS}=0\text{V}$<br>$T_J=55^\circ\text{C}$                 |     | 0.004      | 1<br>5   | $\mu\text{A}$    |
| $I_{GSS}$                   | Gate-Body leakage current             | $V_{DS}=0\text{V}$ , $V_{GS}=\pm 20\text{V}$                                       |     |            | 100      | nA               |
| $V_{GS(th)}$                | Gate Threshold Voltage                | $V_{DS}=V_{GS}$ , $I_D=250\mu\text{A}$                                             | 1   | 1.9        | 3        | V                |
| $I_{D(ON)}$                 | On state drain current                | $V_{GS}=4.5\text{V}$ , $V_{DS}=5\text{V}$                                          | 20  |            |          | A                |
| $R_{DS(ON)}$                | Static Drain-Source On-Resistance     | $V_{GS}=10\text{V}$ , $I_D=8.5\text{A}$<br>$T_J=125^\circ\text{C}$                 |     | 20<br>29.2 | 26<br>38 | $\text{m}\Omega$ |
|                             |                                       | $V_{GS}=4.5\text{V}$ , $I_D=5\text{A}$                                             |     | 31         | 40       | $\text{m}\Omega$ |
|                             |                                       |                                                                                    |     |            |          |                  |
| $g_{FS}$                    | Forward Transconductance              | $V_{DS}=5\text{V}$ , $I_D=5\text{A}$                                               | 10  | 17         |          | S                |
| $V_{SD}$                    | Diode Forward Voltage                 | $I_S=1\text{A}$ , $V_{GS}=0\text{V}$                                               |     | 0.76       | 1        | V                |
| $I_S$                       | Maximum Body-Diode Continuous Current |                                                                                    |     |            | 4.3      | A                |
| <b>DYNAMIC PARAMETERS</b>   |                                       |                                                                                    |     |            |          |                  |
| $C_{iss}$                   | Input Capacitance                     | $V_{GS}=0\text{V}$ , $V_{DS}=15\text{V}$ , $f=1\text{MHz}$                         |     | 680        | 820      | pF               |
| $C_{oss}$                   | Output Capacitance                    |                                                                                    |     | 102        |          | pF               |
| $C_{rss}$                   | Reverse Transfer Capacitance          |                                                                                    |     | 77         |          | pF               |
| $R_g$                       | Gate resistance                       | $V_{GS}=0\text{V}$ , $V_{DS}=0\text{V}$ , $f=1\text{MHz}$                          |     | 3          | 3.6      | $\Omega$         |
| <b>SWITCHING PARAMETERS</b> |                                       |                                                                                    |     |            |          |                  |
| $Q_g(10\text{V})$           | Total Gate Charge                     | $V_{GS}=10\text{V}$ , $V_{DS}=15\text{V}$ , $I_D=8.5\text{A}$                      |     | 13.84      | 17       | nC               |
| $Q_g(4.5\text{V})$          | Total Gate Charge                     |                                                                                    |     | 6.74       | 8.1      | nC               |
| $Q_{gs}$                    | Gate Source Charge                    |                                                                                    |     | 1.84       |          | nC               |
| $Q_{gd}$                    | Gate Drain Charge                     |                                                                                    |     | 3.32       |          | nC               |
| $t_{D(on)}$                 | Turn-On DelayTime                     | $V_{GS}=10\text{V}$ , $V_{DS}=15\text{V}$ , $R_L=1.8\Omega$ ,<br>$R_{GEN}=3\Omega$ |     | 4.5        | 6.5      | ns               |
| $t_r$                       | Turn-On Rise Time                     |                                                                                    |     | 4.2        | 6.3      | ns               |
| $t_{D(off)}$                | Turn-Off DelayTime                    |                                                                                    |     | 20.1       | 30       | ns               |
| $t_f$                       | Turn-Off Fall Time                    |                                                                                    |     | 4.9        | 7.5      | ns               |
| $t_{rr}$                    | Body Diode Reverse Recovery Time      | $I_F=8.5\text{A}$ , $dI/dt=100\text{A}/\mu\text{s}$                                |     | 17.2       | 21       | ns               |
| $Q_{rr}$                    | Body Diode Reverse Recovery Charge    | $I_F=8.5\text{A}$ , $dI/dt=100\text{A}/\mu\text{s}$                                |     | 8.6        | 10       | nC               |

A: The value of  $R_{\theta JA}$  is measured with the device mounted on 1in<sup>2</sup> FR-4 board with 2oz. Copper, in a still air environment with  $T_A=25^\circ\text{C}$ . The value in any given application depends on the user's specific board design. The current rating is based on the  $t \leq 10\text{s}$  thermal resistance rating.

B: Repetitive rating, pulse width limited by junction temperature.

C: The  $R_{\theta JA}$  is the sum of the thermal impedance from junction to lead  $R_{\theta JL}$  and lead to ambient.

D: The static characteristics in Figures 1 to 6 are obtained using 80 $\mu\text{s}$  pulses, duty cycle 0.5% max.

E: These tests are performed with the device mounted on 1 in<sup>2</sup> FR-4 board with 2oz. Copper, in a still air environment with  $T_A=25^\circ\text{C}$ . The SOA curve provides a single pulse rating.

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TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

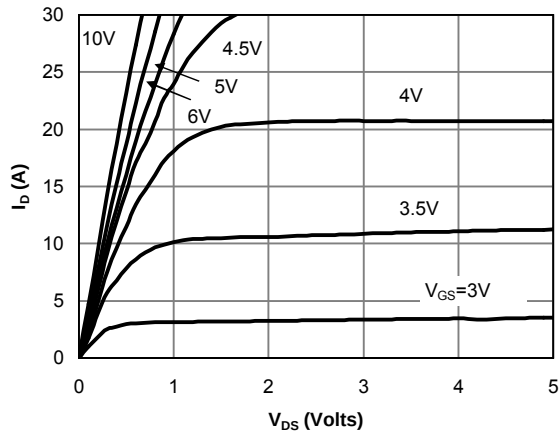


Fig 1: On-Region Characteristics

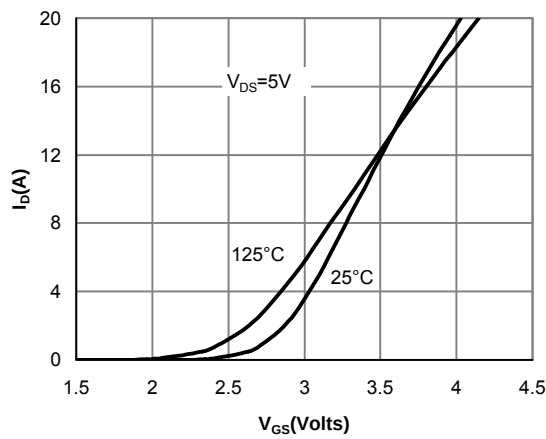


Figure 2: Transfer Characteristics

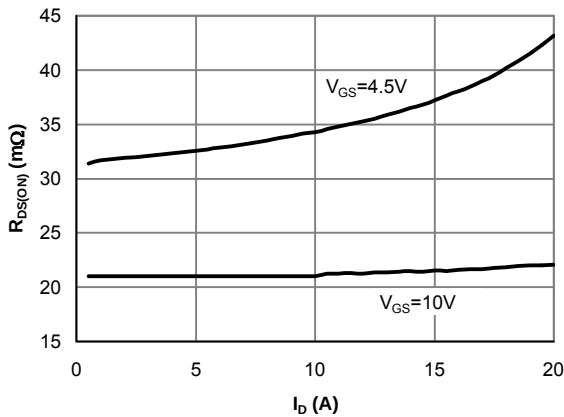


Figure 3: On-Resistance vs. Drain Current and Gate Voltage

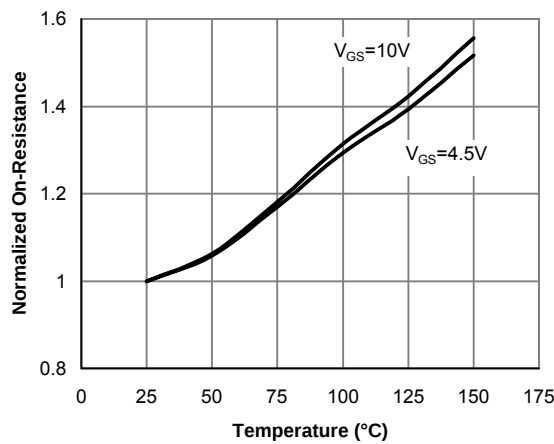


Figure 4: On-Resistance vs. Junction Temperature

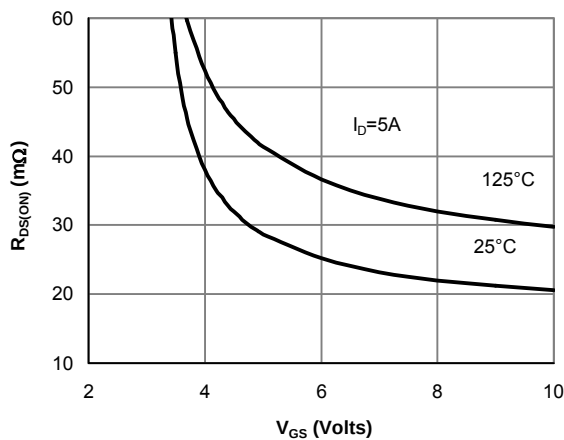


Figure 5: On-Resistance vs. Gate-Source Voltage

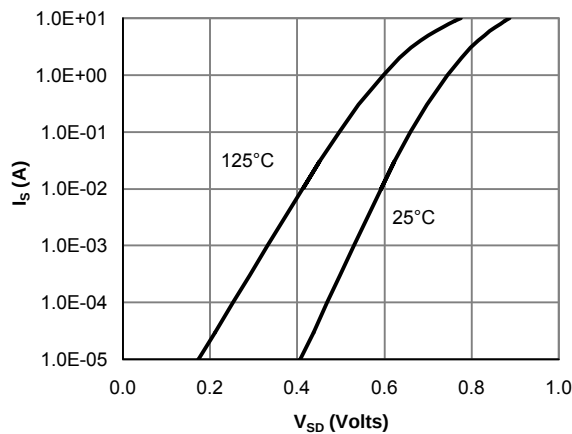


Figure 6: Body-Diode Characteristics

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